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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.
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09/352,194 07/13/99 YAMAZAKI

S - 0756-1998

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EXAMINER

TOLEDO, E

ART UNIT

PAPER NUMBER

2823

DATE MAILED:

10/24/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

Office Action Summary

Application No.

09/352,194

Applicant(s)

YAMAZAKI ET AL.

Examiner

Fernando Toledo

Art Unit

2823

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 30 July 2001.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 5 and 36-54 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 5 and 36-54 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 13 July 1999 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on _____ is: a) ☐ approved b) ☐ disapproved by the Examiner.
If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

- 13) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
* See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892) 4) ☐ Interview Summary (PTO-413) Paper No(s). _____
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948) 5) ☐ Notice of Informal Patent Application (PTO-152)
- 3) ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) 18&20 6) ☐ Other: _____

DETAILED ACTION

Claim Objections

Claims 49 – 54 are objected to under 37 CFR 1.75(c) as being in improper form because a multiple dependent claim should refer to other claims in the *alternative* only. See MPEP § 608.01(n). Accordingly, the claims have not been further treated on the merits.

Applicant is advised that should claims 38 and 44 be found allowable, claims 47 and 48 will be objected to under 37 CFR 1.75 as being a substantial duplicate thereof. When two claims in an application are duplicates or else are so close in content that they both cover the same thing, despite a slight difference in wording, it is proper after allowing one claim to object to the other as being a substantial duplicate of the allowed claim. See MPEP § 706.03(k).

Double Patenting

Claims 5 and 36 – 54 of this application conflict with claims 1 – 18 of Application No. 09/894,125. 37 CFR 1.78(b) provides that when two or more applications filed by the same applicant contain conflicting claims, elimination of such claims from all but one application may be required in the absence of good and sufficient reason for their retention during pendency in more than one application. Applicant is required to either cancel the conflicting claims from all but one application or maintain a clear line of demarcation between the applications. See MPEP § 822.

Claims 5 and 36 – 54 are provisionally rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1 – 18 of copending Application No. 09/894,125 in view of Takemura (U. S. patent 5,616,506). The copending Application No. 09/894,125 substantially disclose the claimed invention of the present Application.

However, the copending Application No. 09/894,125 does not recite the limitation “providing the semiconductor film with a catalytic element for facilitating a crystallization of the semiconductor film.” Takemura in the U. S. patent 5,616,506; discloses that nickel is added as a catalyst to an amorphous silicon film in order to promote crystallization of the silicon film (column 6; lines 31 – 35).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to add nickel to the silicon layer of copending Application No. 09/894,125 because as taught by Takemura it will promote the crystallization of the silicon film (column 6, lines 31 – 35).

This is a provisional obviousness-type double patenting rejection.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 5 and 36 – 48 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takemura in view of Zhang et al. (U. S. patent 5,569,610).

In re claims 5 and 36 – 48; Takemura teaches forming a semiconductor film comprising silicon over a substrate (column 6); providing the semiconductor film with a catalytic element (i.e. nickel) for facilitating a crystallization of the semiconductor film (column 6); removing an oxide film 104 from a surface of the semiconductor film by etching (column 6 and figures 4a – 4d); leveling the surface of the semiconductor film by heating after removing the oxide film (column 7).

Takemura does not teach wherein the semiconductor film is irradiated with a laser light in air for crystallizing the semiconductor film providing the catalytic element.

However, Zhang in the U. S. patent 5,569,610; show carrying out a first heat treatment of an amorphous silicon film to form a thin film transistor with an excimer laser having a light with a wavelength of 248 nm to crystallize the amorphous silicon (column 5).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use a laser as taught by Zhang to crystallize the amorphous silicon of Takemura since Zhang will enable the practitioners of Takemura to heat treat the amorphous silicon film with a laser irradiating UV light.

In re claims 36, 39, 42 and 45; Takemura teaches that the second heat treatment takes place in a reducing atmosphere that contains hydrogen (column 7). The term reducing atmosphere is interpreted as requiring some atmosphere that contains a

reducing agent such as HCl. See In re Zletz, 13 USPQ2d 1320 (Fed. Cir. 1989)(Claims are given their broadest possible interpretation during PTO prosecution). It is noted that the specification does not set forth an explicit definition for what Applicant regards as a reducing atmosphere.

Claims 37 – 40, 43 , 44, 46 – 48 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takemura in view of Zhang (U. S. patent 5,569,610) and Zhang (U. S. patent 5,888,857).

In re claims 37, 40, 43 and 46; Takemura in view of Zhang (U. S. patent 5,569,610) do not show wherein the leveling process is carried out by heating in a inert gas.

However, Zhang in the U. S. patent 5,888,857; teaches that a second annealing carried out in an atmosphere of an inert gas (i.e. nitrogen) because it will promote further crystal growth (columns 7 and 8).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to carry out the leveling process of Takemura in an atmosphere of an inert gas because as taught by Zhang it will promote the crystal growth of the semiconductor layer.

In re claims 38 – 40, 44 – 48; Takemura in view of Zhang (U. S. patent 5,569,610) do not show wherein the leveling is carried out wherein the concentration of oxygen is 10 ppm or less.

However, Zhang in the U. S. patent 5,888,857; teaches that the leveling process can be done in an environment void of oxygen to prevent the silicon from reacting with oxygen thereby preventing the formation of silicon oxide, which, inhibits further crystallization of the amorphous silicon film (column 7 and 8).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to level the semiconductor substrate by carrying a heating process as taught by Takemura in an environment with an oxygen concentration of 10 ppm or less as taught by Zhang (U. S. patent 5,888,857) to promote further crystalline growth.

Claims 41 – 45 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takemura, Zhang (U. S. patent 5,569,610) and Zhang (U. S. patent 5,888,857) in view of Ohtani et al. (U. S. patent 6,285,042 B1).

Takemura in view of Zhang (U. S. patent 5,569,610) and Zhang (U. S. patent 5,888,857) do not show using hydrofluoric acid to etch away the silicon oxide layer.

However, Ohtani in the U. S. patent 6,285,040 B1 and related text, shows that it is conventional to remove a silicon oxide film, from a crystalline silicon layer that is used to form a TFT, by using hydrofluoric acid (HF_{aq}) as the etchant since silicon oxide is very selective to HF_{aq} (column 9).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use HF_{aq} as taught by Ohtani, to remove the silicon

oxide of Takemura since it is conventional absent evidence to the contrary to use HF_{aq} as an etchant of silicon oxide.

Response to Arguments

Applicant's arguments with respect to claim 5 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

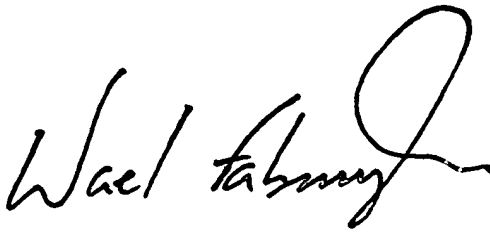
Any inquiry concerning this communication or earlier communications from the examiner should be directed to Fernando Toledo whose telephone number is (703) 305-0567. The examiner can normally be reached on Monday – Friday, 8am – 4pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (703) 308-4918. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

	Fernando Toledo Patent Examiner Art Unit 2823
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ft
October 11, 2001


SUPERVISORY PRIMARY EXAMINER
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